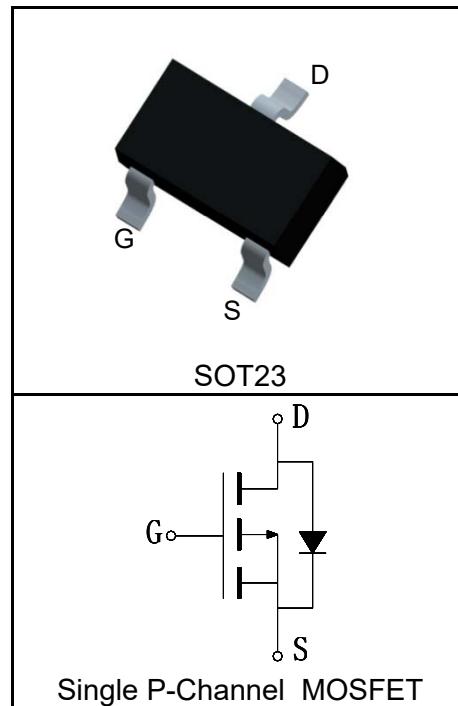


Features

- -20V/-3A,
- $R_{DS\ (ON)} = 70m\Omega$ (Typ.)@ $V_{GS}=-4.5V$
- $R_{DS\ (ON)} = 100m\Omega$ (Typ.)@ $V_{GS}=-2.5V$
- Low $R_{DS\ (ON)}$
- Super High Dense Cell Design
- Reliable and Rugged

Pin Description



Applications

- Load Switch



Halogen-Free

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
Common Ratings ($T_A=25^\circ C$ Unless Otherwise Noted)			
V_{DSS}	Drain-Source Voltage	-20	V
V_{GSS}	Gate-Source Voltage	± 12	
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_A=25^\circ C$	-1.2
			A
Mounted on Large Heat Sink			
$I_{DP}^{(1)}$	300μs Pulse Drain Current Tested	$T_A=25^\circ C$	-12
$I_D^{(2)}$	Continuous Drain Current($V_{GS}=-4.5V$)	$T_A=25^\circ C$	-3
		$T_A=70^\circ C$	-2.4
P_D	Maximum Power Dissipation	$T_A=25^\circ C$	1
		$T_A=70^\circ C$	0.64
$R_{\theta JC}$	Thermal Resistance-Junction to Case	-	°C/W
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	125	°C/W
Drain-Source Avalanche Ratings			
$E_{AS}^{(4)}$	Avalanche Energy, Single Pulsed	TBD	mJ

Electrical Characteristics (T_A=25°C Unless Otherwise Noted)

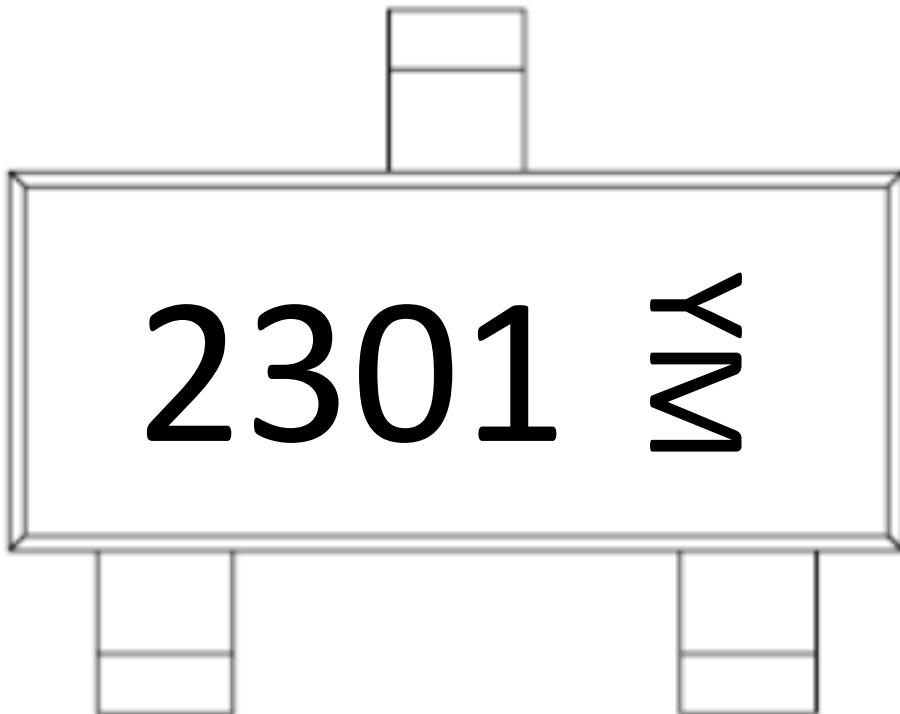
Symbol	Parameter	Test Condition	KS2301AA			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =-250μA	-20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V			-1	μA
		T _J =125°C			-30	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =-250μA	-0.4	-0.7	-1	V
I _{GSS}	Gate Leakage Current	V _{GS} =±12V, V _{DS} =0V			±100	nA
R _{DS(ON)} ^⑤	Drain-Source On-state Resistance	V _{GS} =-4.5V, I _{DS} =-3A		70	96	mΩ
		V _{GS} =-2.5V, I _{DS} =-2A		100	145	mΩ
Diode Characteristics						
V _{SD} ^⑤	Diode Forward Voltage	I _{SD} =-3A, V _{GS} =0V		-0.8	-1.2	V
t _{rr}	Reverse Recovery Time	I _{SD} =-3A, dI _{SD} /dt=-100A/μs		21		ns
Q _{rr}	Reverse Recovery Charge			6		nC
Dynamic Characteristics^⑥						
R _G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz		2		Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-10V, Frequency=1.0MHz		480		pF
C _{oss}	Output Capacitance			85		
C _{rss}	Reverse Transfer Capacitance			55		
t _{d(ON)}	Turn-on Delay Time	V _{DD} =-10V, I _{DS} =-3A, V _{GEN} =-4.5V, R _G =6Ω		12		ns
t _r	Turn-on Rise Time			55		
t _{d(OFF)}	Turn-off Delay Time			19		
t _f	Turn-off Fall Time			11		
Gate Charge Characteristics^⑥						
Q _g	Total Gate Charge	V _{DS} =-16V, V _{GS} =-4.5V, I _{DS} =-3A		4		nC
Q _{gs}	Gate-Source Charge			0.7		
Q _{gd}	Gate-Drain Charge			1.2		

Notes:

- ①Pulse width limited by safe operating area.
- ②Calculated continuous current based on maximum allowable junction temperature.
- ③When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.
- ④Limited by T_{Jmax}. Starting T_J = 25°C.
- ⑤Pulse test; Pulse width≤300μs, duty cycle≤2%.
- ⑥Guaranteed by design, not subject to production testing.

Ordering and Marking Information

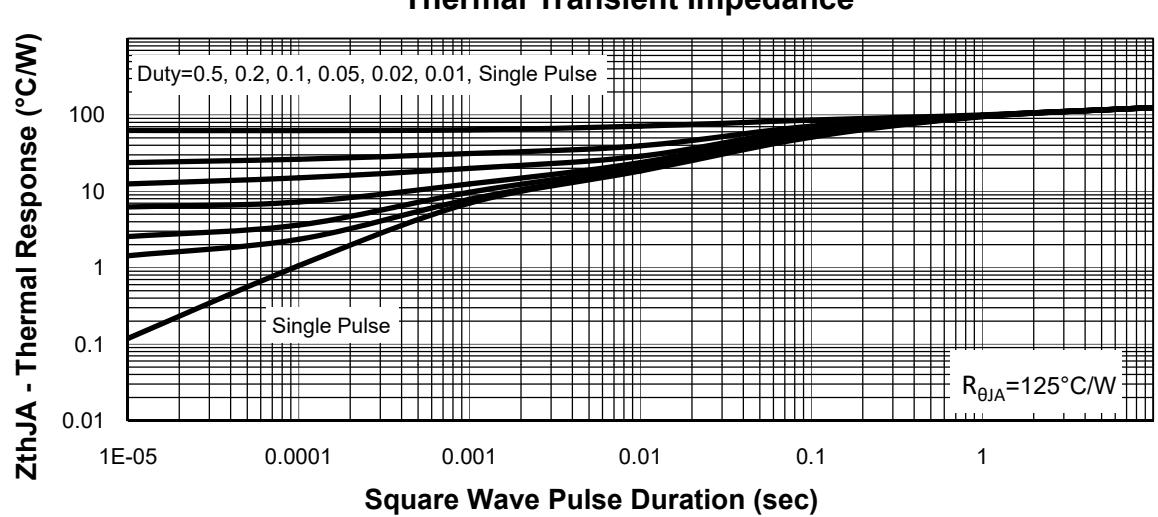
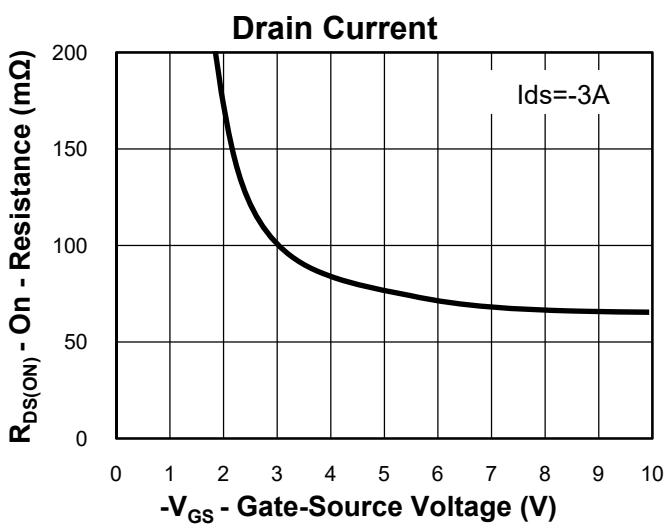
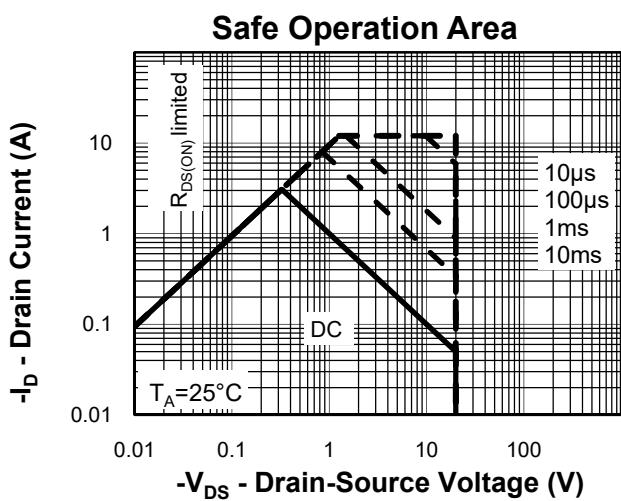
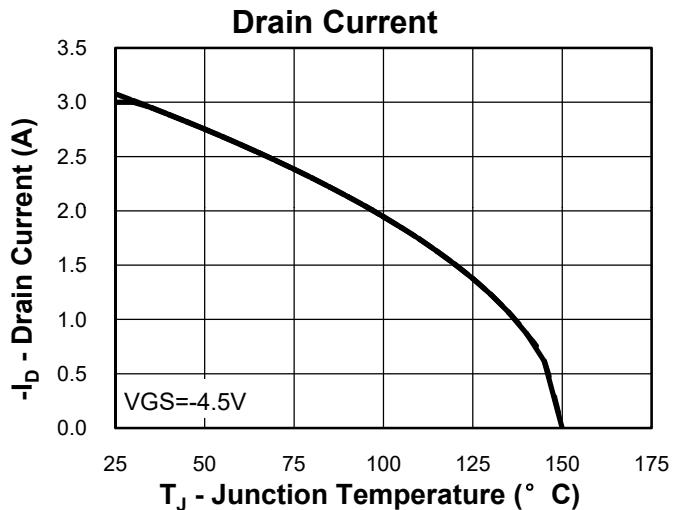
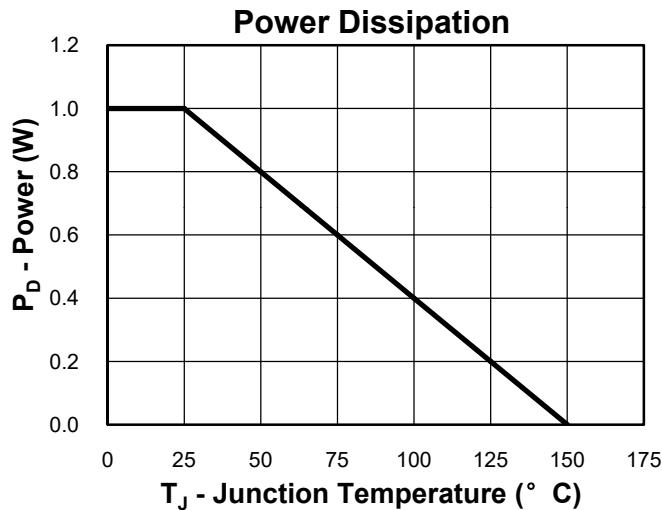
Device	Package	Packaging	Quantity	Reel Size	Tape width
KS2301AA	SOT23	Tape&Reel	3000	7"	8mm



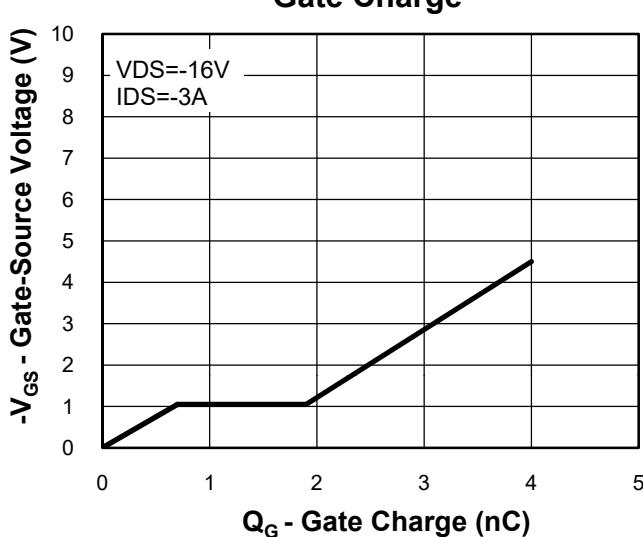
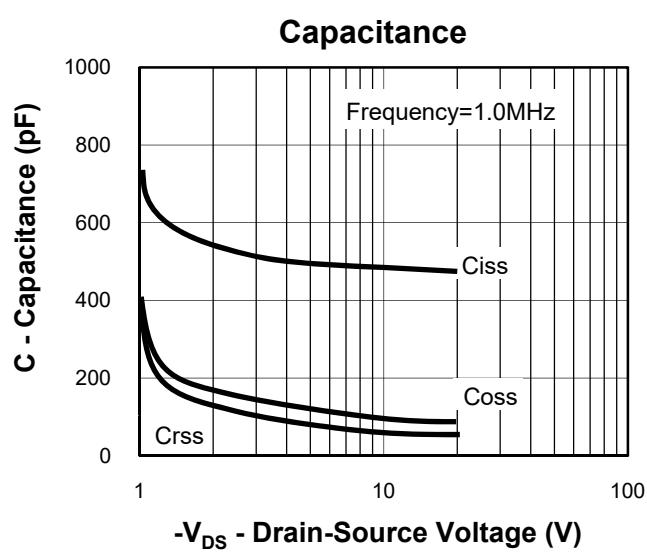
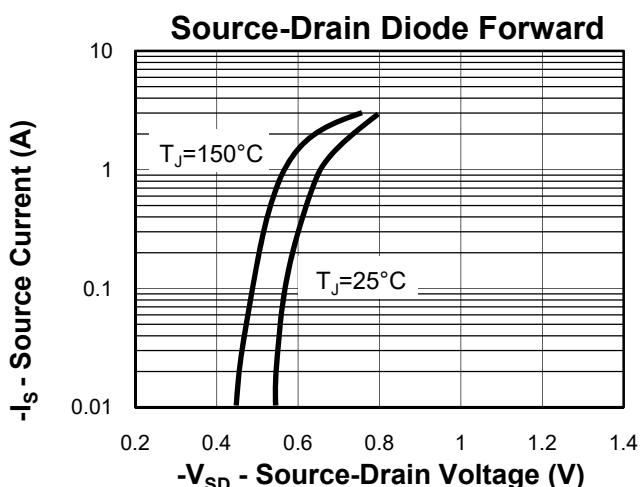
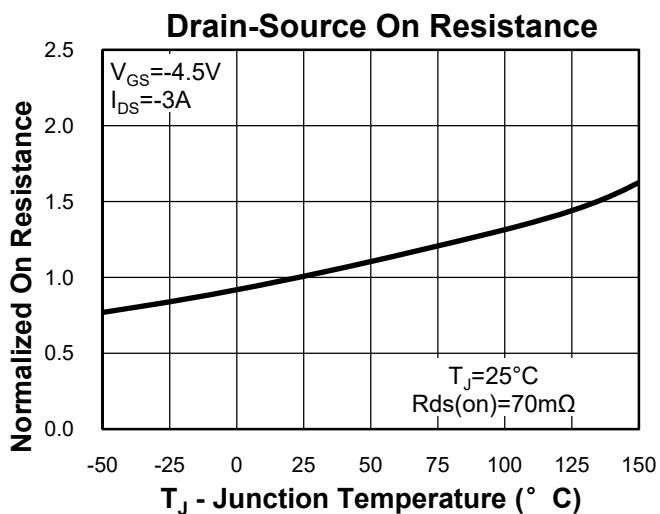
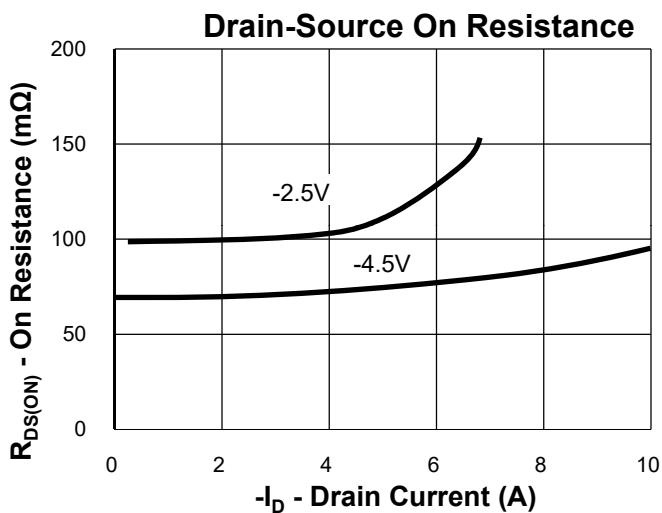
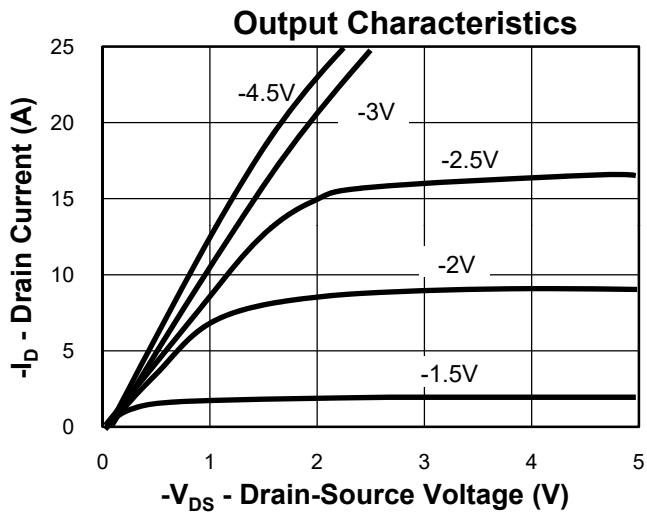
Y =Year,2017-A,2018-B,etc.

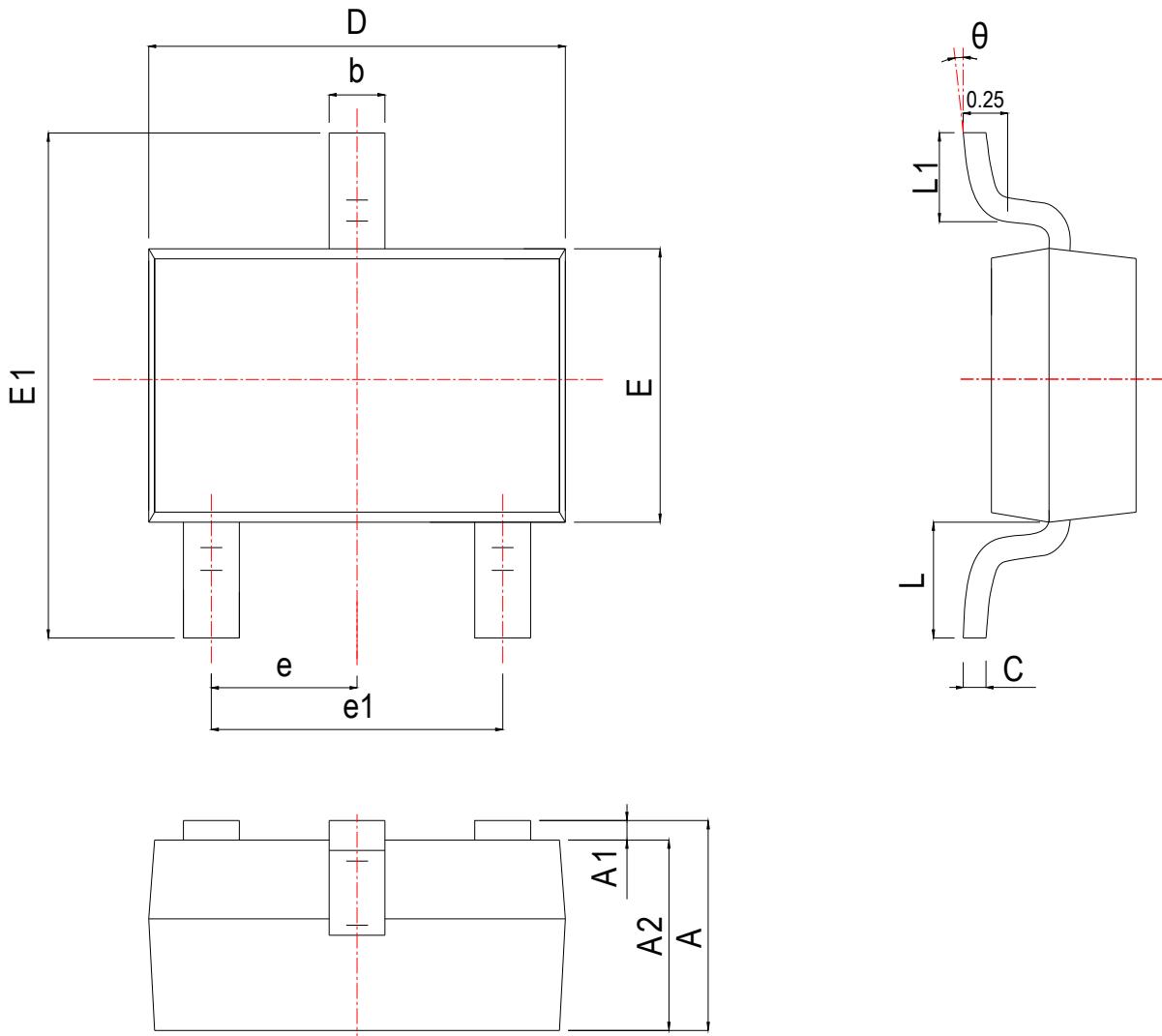
M =Month,Jan-1,Feb-2,...,Sep-9,Oct-A,Nov-B,Dec-C.

Typical Characteristics



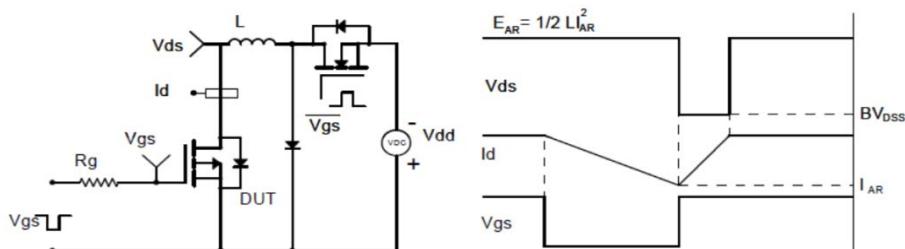
Typical Characteristics



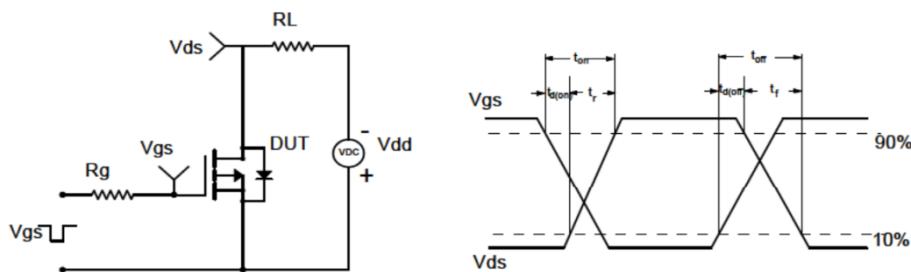
Package Information
SOT23


SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.900	1.025	1.150	0.035	0.040	0.045
A1	0.050	0.075	0.100	0.002	0.003	0.004
A2	0.900	0.975	1.020	0.035	0.038	0.040
b	0.300	0.400	0.500	0.012	0.016	0.020
c	0.080	0.115	0.150	0.003	0.005	0.006
D	2.800	2.900	3.000	0.110	0.114	0.118
E	1.200	1.300	1.400	0.047	0.051	0.055
E1	2.250	2.400	2.550	0.089	0.094	0.100
e	0.950 TYP			0.037 TYP		
e1	1.800	1.900	2.000	0.071	0.075	0.079
L	0.540 REF			0.021 REF		
L1	0.400	0.500	0.600	0.016	0.018	0.020
theta	0°	*	8°	0°	*	8°

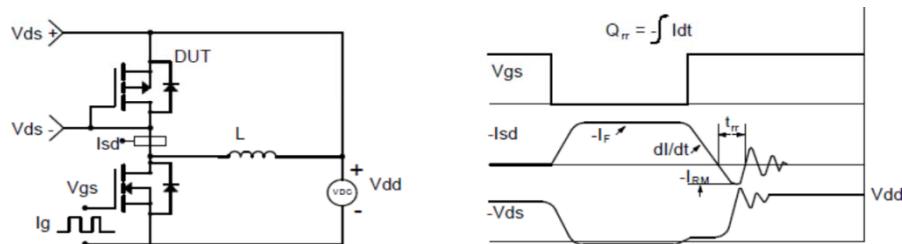
Avalanche Test Circuit and Waveforms



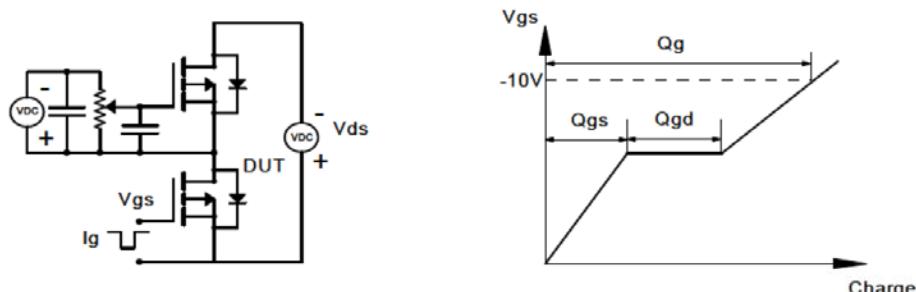
Switching Time Test Circuit and Waveforms



Diode Recovery Test Circuit and Waveforms



Gate Charge Test Circuit and Waveform



Customer Service

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